

CLP-113-02-L-D-P

CLP-113-02-L-D-P Information

som heisener.com	Part Number Manufacturer Category	CLP-113-02-L-D-P Samtec Inc. Connectors, Interconnects Rectangular Connectors - Headers, Receptacles, Female Sockets	
	Description	.050" X .050	
	Package	-	
For Reference Only		For the pricing/inventory/lead time, please contact us Website: https://www.heisener.com	Request a Quote
		E-mail: salesdept@heisener.com	Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



CLP-113-02-L-D-P Specifications

Manufacturer Part NumberCLP-113-02-L-D-PManufacturerSamtec Inc.CategoryConnectors, InterconnectsPackage-SeriesCLPConnector TypeReceptacles, Female SocketsContact TypeReceptacleSoriesCLPContact TypeBoard to BoardNumber of Positions26Number of Positions LoadedAllNumber of Rows0.050° (1.27mm)Number of Rows0.050° (1.27mm)Number of RowsSuface MountYereninationSolderTerminationSolderFastening TypeSuface MountContact Finish Thickness - Mating0.04" (0.25µm)Insulation Height0.084" (2.14mm)		
CategoryConnectors, Interconnects Rectangular Connectors - Headers, Receptacles, Female SocketsPackage-SeriesCLPConnector TypeReceptacleConnector TypeFemale SocketStyleBoard to BoardNumber of Positions26Number of Positions LoadedAllPitch - Mating0.050° (1.27mm)Number of Rows2Row Spacing - MatingSolderMounting TypeSurface MountFreminationSolderFreminationGoldContact Finish - MatingGoldInsulation ColorBlackInsulation Height0.084" (2.14mm)	Manufacturer Part Number	CLP-113-02-L-D-P
NumberRectangular Connectors - Headers, Receptacles, Female SocketsPackage-SeriesCLPConnector TypeReceptacleContact TypeFemale SocketStyleBoard to BoardNumber of Positions26Number of Positions LoadedAllPitch - Mating0.050" (1.27mm)Number of Rows2Row Spacing - Mating0.050" (1.27mm)Mounting TypeSurface MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldContact Finish - MatingIpuin (0.25µm)Insulation ColorBlackInsulation Height0.084" (2.14mm)	Manufacturer	Samtec Inc.
Package-SeriesCLPConnector TypeReceptacleContact TypeFemale SocketStyleBoard to BoardNumber of Positions26Number of Positions LoadedAllPitch - Mating0.050" (1.27mm)Number of Rows2Row Spacing - Mating0.050" (1.27mm)Mounting TypeSurface MountFastening TypeSolderFastening TypeGoldContact Finish - MatingGoldInsulation ColorBlackInsulation Height0.084" (2.14mm)	Category	Connectors, Interconnects
SeriesCLPConnector TypeReceptacleContact TypeFemale SocketStyleBoard to BoardNumber of Positions26Number of Positions LoadedAllPitch - Mating0.050" (1.27mm)Number of Rows2Row Spacing - Mating0.050" (1.27mm)Mounting TypeSurface MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldInsulation ColorBlackInsulation Height0.084" (2.14mm)		Rectangular Connectors - Headers, Receptacles, Female Sockets
Connector TypeReceptacleContact TypeFemale SocketStyleBoard to BoardNumber of Positions26Number of Positions LoadedAllPitch - Mating0.050" (1.27mm)Number of Rows2Row Spacing - Mating0.050" (1.27mm)Mounting TypeSurface MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldIontact Finish Thickness - Mating0.050" (0.25µm)Insulation ColorBlackInsulation Height0.084" (2.14mm)	Package	-
Contact TypeFemale SocketStyleBoard to BoardNumber of Positions26Number of Positions LoadedAllPitch - Mating0.050" (1.27mm)Number of Rows2Row Spacing - Mating0.050" (1.27mm)Mounting TypeSurface MountTerminationSolderFastening TypePush-PullContact Finish - Mating0.0ju (0.25µm)Insulation ColorBlackInsulation Height0.084" (2.14mm)	Series	CLP
StyleBoard to BoardNumber of Positions26Number of Positions LoadedAllPitch - Mating0.050" (1.27mm)Number of Rows2Row Spacing - Mating0.050" (1.27mm)Mounting TypeSurface MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldInsulation ColorBlackInsulation Height0.084" (2.14mm)	Connector Type	Receptacle
Number of Positions26Number of Positions LoadedAllPitch - Mating0.050" (1.27mm)Number of Rows2Row Spacing - Mating0.050" (1.27mm)Mounting TypeSurface MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldContact Finish Thickness - Mating10µin (0.25µm)Insulation ColorBlackInsulation Height0.084" (2.14mm)	Contact Type	Female Socket
Number of Positions LoadedAllPitch - Mating0.050" (1.27mm)Number of Rows2Row Spacing - Mating0.050" (1.27mm)Mounting TypeSurface MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldContact Finish Thickness - Mating10µin (0.25µm)Insulation ColorBlackInsulation Height0.084" (2.14mm)	Style	Board to Board
Pitch - Mating0.050" (1.27mm)Number of Rows2Row Spacing - Mating0.050" (1.27mm)Mounting TypeSurface MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldContact Finish Thickness - MatingIupin (0.25µm)Insulation ColorBlackInsulation Height0.084" (2.14mm)	Number of Positions	26
Number of Rows2Row Spacing - Mating0.050" (1.27mm)Mounting TypeSurface MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldContact Finish Thickness - Mating10µin (0.25µm)Insulation ColorBlackInsulation Height0.084" (2.14mm)	Number of Positions Loaded	All
Row Spacing - Mating0.050" (1.27mm)Mounting TypeSurface MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldContact Finish Thickness - Mating10µin (0.25µm)Insulation ColorBlackInsulation Height0.084" (2.14mm)	Pitch - Mating	0.050" (1.27mm)
Mounting TypeSurface MountTerminationSolderFastening TypePush-PullContact Finish - MatingGoldContact Finish Thickness - Mating10µin (0.25µm)Insulation ColorBlackInsulation Height0.084" (2.14mm)	Number of Rows	2
TerminationSolderFastening TypePush-PullContact Finish - MatingGoldContact Finish Thickness - Mating10µin (0.25µm)Insulation ColorBlackInsulation Height0.084" (2.14mm)	Row Spacing - Mating	0.050" (1.27mm)
Fastening TypePush-PullContact Finish - MatingGoldContact Finish Thickness - Mating10µin (0.25µm)Insulation ColorBlackInsulation Height0.084" (2.14mm)	Mounting Type	Surface Mount
Contact Finish - MatingGoldContact Finish Thickness - Mating10µin (0.25µm)Insulation ColorBlackInsulation Height0.084" (2.14mm)	Termination	Solder
Contact Finish Thickness - Mating10μin (0.25μm)Insulation ColorBlackInsulation Height0.084" (2.14mm)	Fastening Type	Push-Pull
Insulation ColorBlackInsulation Height0.084" (2.14mm)	Contact Finish - Mating	Gold
Insulation Height 0.084" (2.14mm)	Contact Finish Thickness - Mating	10μin (0.25μm)
	Insulation Color	Black
Contact Length - Post -	Insulation Height	0.084" (2.14mm)
č	Contact Length - Post	-
Operating Temperature $-55^{\circ}C \sim 125^{\circ}C$	Operating Temperature	-55°C ~ 125°C
Material Flammability Rating UL94 V-0	Material Flammability Rating	UL94 V-0

Contact Finish - Post	Tin
Mated Stacking Heights	-
Ingress Protection	-
Features	Pick and Place
	Report errors?

CLP-113-02-L-D-P Guarantees



Quality Guarantees

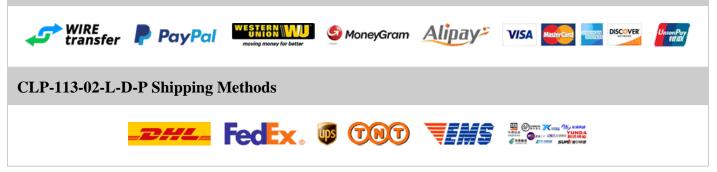
We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

CLP-113-02-L-D-P Payment Methods



If you have any question about CLP-113-02-L-D-P, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com